# DATA SHEET

# MOS FIELD EFFECT TRANSISTOR **2SK2355, 2SK2355-Z/2SK2356, 2SK2356-Z**

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The 2SK2355, 2SK2355-Z/2SK2356, 2SK2356-Z is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

## FEATURES

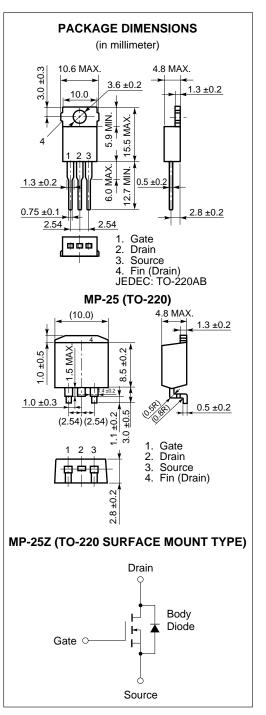
- Low On-Resistance
  2SK2355: RDS(on) = 1.4 Ω (VGS = 10 V, ID = 2.5 A)
  2SK2356: RDS(on) = 1.5 Ω (VGS = 10 V, ID = 2.5 A)
- Low Ciss Ciss = 670 pF TYP.
- High Avalanche Capability Ratings

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C)

Drain to Source Voltage (2SK2355/2356)	Vdss	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D(DC)	±5.0	А
Drain Current (pulse)*	D(pulse)	±20	А
Total Power Dissipation (Tc = 25 °C)	P <sub>T1</sub>	50	W
Total Power Dissipation (Ta = 25 °C)	Рт2	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg -	–55 to +150	°C
Single Avalanche Current**	las	5.0	А
Single Avalanche Energy**	Eas	17.4	mJ

\* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

\*\* Starting Tch = 25 °C, RG = 25  $\Omega$ , VGs = 20 V  $\rightarrow$  0



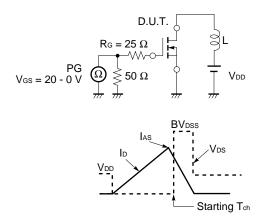
The information in this document is subject to change without notice.

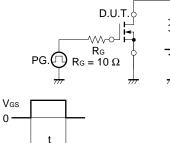
# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

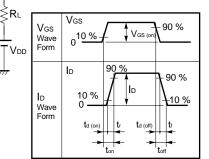
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS(on)		0.9	1.4	mΩ	Vgs = 10 V	2SK2355
			1.0	1.5		ID = 2.5 A	2SK2356
Gate to Source Cutoff Voltage	VGS(off)	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	
Forward Transfer Admittance	y <sub>fs</sub>	1.0			S	Vds = 10 V, Id = 2.5 A	
Drain Leakage Current	IDSS			100	μA	Vds = Vdss, Vgs = 0	
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ Vds} = 0$	
Input Capacitance	Ciss		670		pF	Vds = 10 V	
Output Capacitance	Coss		140		pF	Vgs = 0	
Reverse Transfer Capacitance	Crss		18		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		11		ns	ID = 2.5 A	
Rise Time	tr		8		ns	Vgs = 10 V	
Turn-Off Delay Time	td(off)		40		ns	Vdd = 150 V	
Fall Time	tr		8		ns	$R_G = 10 \ \Omega$ $R_L = 60 \ \Omega$	
Total Gate Charge	QG		20		nC	ID = 5.0 A	
Gate to Source Charge	Q <sub>GS</sub>		4.5		nC	VDD = 400 V	
Gate to Drain Charge	Qgd		9		nC	Vgs = 10 V	
Body Diode Forward Voltage	VF(S-D)		1.0		V	IF = 5.0 A, Vo	ss = 0
Reverse Recovery Time	trr		270		ns	IF = 5.0 A, Vo	ss = 0
Reverse Recovery Charge	Qrr		1.0		nC	di/dt = 50 A/	ıs

#### Test Circuit 1 Avalanche Capability

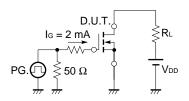
#### Test Circuit 2 Switching Time







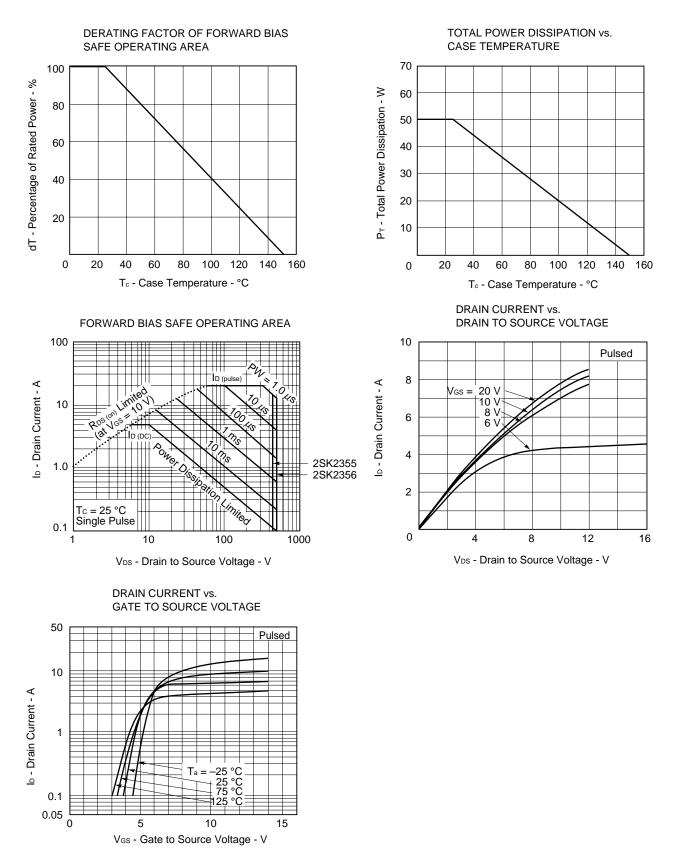
#### Test Circuit 3 Gate Charge

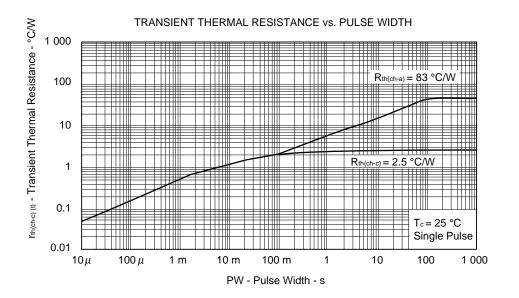


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

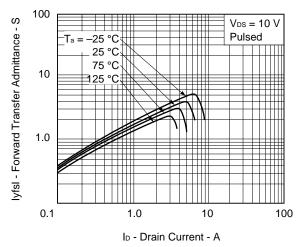
t = 1  $\mu$ s Duty Cycle  $\leq$  1 %

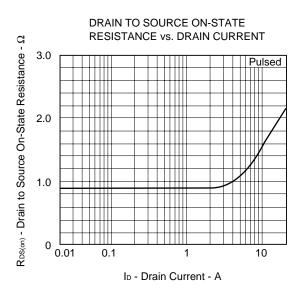
#### TYPICAL CHARACTERISTICS (TA = 25 °C)



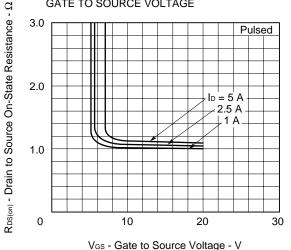


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

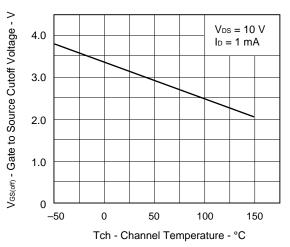


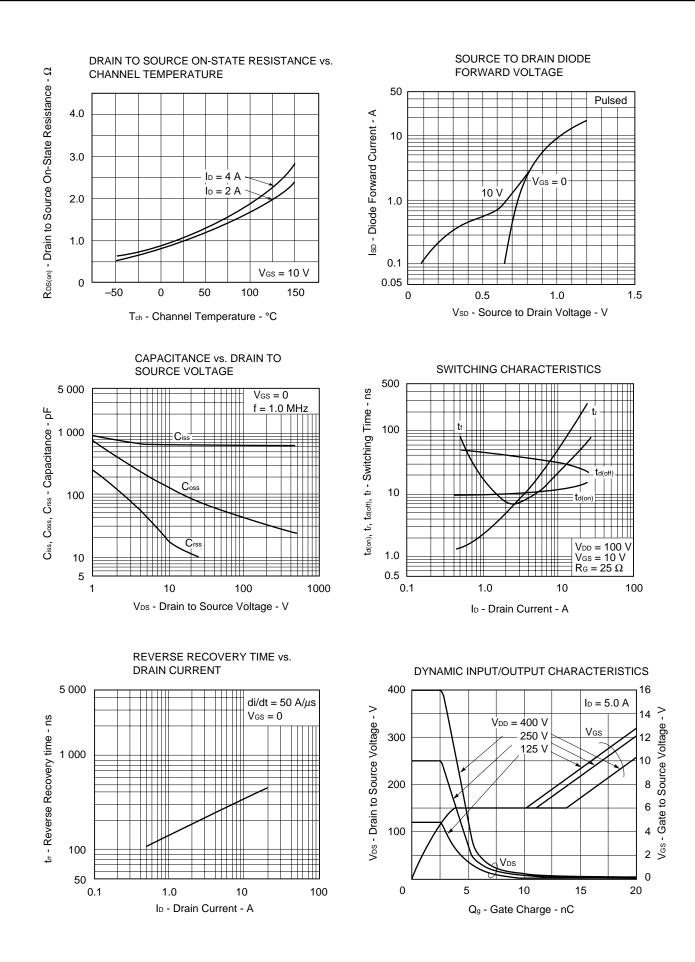


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

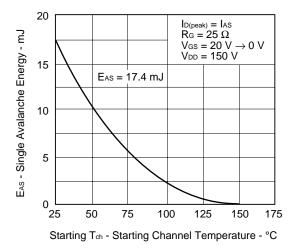


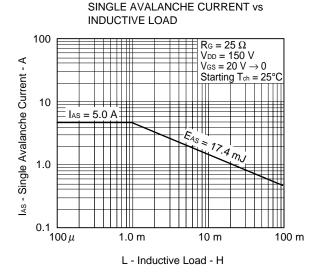






SINGLE AVALANCHE ENERGY vs STARTING CHANNEL TEMPERATURE





## REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	C11745E
Quality grades on NEC semiconductor devices.	C11531E
Semiconductor device mounting technology manual.	C10535E
Semiconductor device package manual.	C10943X
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	X10679E
Power MOS FET features and application switching to power supply.	D12971E
Application circuits using Power MOS FET.	D12972E
Safe operating area of Power MOS FET.	D13085E

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.

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